



17th IEEE Electrical Design of Advanced Packaging and Systems (EDAPS) Symposium

17th December – 19th December, 2024
Bengaluru, INDIA

Sponsorship and exhibitor opportunities

EDAPS is the premier international conference in the Asia-Pacific region on advanced and emerging issues in the electrical modeling, analysis, and design of electronic interconnections, packages, and systems. Over three days, the conference will feature the latest advancements in CAD, design, and measurement techniques for:

- ensuring signal, power, and thermal integrity in high-speed systems;
- optimizing performance in high-speed, RF, wireless and quantum systems.
- enabling heterogeneous integration and packaging for chiplets

EDAPS 2024 will be held in the city of Bengaluru – the Silicon Valley of India with close proximity to more than 100 prominent microelectronic companies, and home to one of the largest talent pools of post-secondary engineering students in Asia.

With an estimate of more than 100 participants from industry and academia all over the globe, we believe EDAPS 2024 will be an excellent opportunity for your organization to promote its products/services, strengthen its brand recognition in the leading international venue in the area, connect with experts and potential customers, and recruit top talents. Please find in the next page the sponsorship and exhibitor opportunities that EDAPS 2024 will offer.

We look forward to seeing you in Bengaluru!

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EDAPS is sponsored by:



Package	Platinum	Gold	Silver	Bronze/Exhibitor
Fee (INR)	> Rs. 5,00,000	Rs. 5,00,000	Rs. 3,00,000	Rs 2,00,000
Maximum number of sponsors	2			
Demo/presentation* in main conference room	20 mins	10 mins		
Training program* to attendees in separate room	1 h	½ h		
Special recognition	Lunch on Day 2 and 3 of conference	Lunch on day of demo (day2 or 3)		
Logo on attendee's lanyard*	✓	✓		
Space in conference proceedings*	2 pages	1 page	½ page	
Promotional brochure or merchandise included in workshop kit*	✓	✓	✓	
Logo* and link included in the conference website and proceedings	✓	✓	✓	✓
Exhibition space (table and 2 chairs, electrical socket, wi-fi)	✓	✓	✓	✓
Recognition during opening and closing ceremonies	✓	✓	✓	✓
Full registrations included	4	2	1	1
Discounted registrations included (50% discount)	4	2	1	-

*: material to be provided by the sponsors or exhibitor

To register as a sponsor or exhibitor, please email sourajeet.roy@ece.iitr.ac.in or rohit@iitrpr.ac.in

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